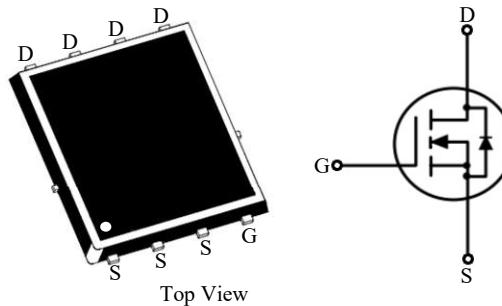


FEATURES

- Low $R_{DS(on)}$
- Suffix "H" indicates Halogen-free parts, ex. STM506N300LSX8H

PIN CONFIGURATION

DFN5x6-8L



D	Drain
G	Gate
S	Source

Maximum Ratings ($T_A = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current $T_C = 25^\circ C$ $T_C = 100^\circ C$	I_D	18.0	A
		12.4	
Pulsed Drain Current (Note 1)	I_{DM}	50	A
Avalanche Current	I_{AS}	8.6	A
Avalanche Energy (Note 2)	E_{AS}	3.7	mJ
Power Dissipation $T_C = 25^\circ C$	P_D	21	W
Thermal Resistance from Junction to Ambient (Note 3)	$R_{\theta JA}$	50	$^\circ C/W$
Thermal Resistance from Junction to Case	$R_{\theta JC}$	6	$^\circ C/W$
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to + 150	$^\circ C$

Note:

1. The data tested by pulsed, pulse width $\leq 100\mu s$, duty cycle $\leq 2\%$, Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)} = 150^\circ C$.

2. Limited by $T_{J(MAX)}$, starting $T_j = 25^\circ C$, $L = 0.1mH$, $R_g = 25\Omega$, $I_{AS} = 8.6A$, $V_{GS} = 10V$.

3. Device mounted on FR-4 substrate PC board, 2oz copper, with 1 inch² copper plate in still air.



STM506N300LSX8H

N-Channel Enhancement Mode Field Effect Transistor

Electrical Characteristics($T_A=25^\circ C$ unless otherwise specified)

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$I_D=10\text{mA}$	$V_{(\text{BR})\text{DSS}}$	60	-	-	V
Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	$V_{GS(\text{th})}$	1.2	-	2.5	V
Zero Gate Voltage Drain Current	$V_{DS}=48\text{V}$	I_{DSS}	-	-	1	μA
Gate Leakage Current	$V_{GS}=\pm 16\text{V}$	I_{GSS}	-	-	± 100	nA
Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=15\text{A}$ $V_{GS}=4.5\text{V}, I_D=10\text{A}$	$R_{DS(\text{on})}$	-	28	33 39	$\text{m}\Omega$
Forward Transconductance	$V_{DS}=5\text{V}, I_D=15\text{A}$	g_{FS}	-	18	-	S
Dynamic						
Gate Resistance	$V_{DS}=0\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$	R_g	-	0.8	-	Ω
Total Gate Charge	$V_{DS}=30\text{V}, V_{GS}=4.5\text{V}, I_D=15\text{A}$	Q_g	-	8.7	-	nC
Gate-Source Charge	$V_{DS}=30\text{V}, V_{GS}=10\text{V}, I_D=15\text{A}$	Q_{gs}	-	19.0	-	
Gate-Drain Charge			-	4.3	-	
Input Capacitance		C_{iss}	-	1260	-	pF
Output Capacitance	$V_{DS}=30\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$	C_{oss}	-	47	-	
Reverse Transfer Capacitance		C_{rss}	-	43	-	
Turn on Delay Time		$t_{d(on)}$	-	11	-	ns
Turn on Rise Time	$V_{DS}=30\text{V}, I_D=15\text{A}$	t_r	-	27	-	
Turn off Delay Time		$t_{d(off)}$	-	10	-	
Turn off Fall Time	$V_{GS}=10\text{V}, R_g=3.3\Omega$	t_f	-	2	-	
Drain-Source Body Diode						
Diode Forward Voltage	$V_{GS}=0\text{V}, I_S=1\text{A}$	V_{SD}	-	-	1.3	V
Diode Continuous Forward Current	-	I_S	-	-	18	A
Diode Pulse Current		I_{SM}	-	-	50	A
Reverse Recovery Time	$I_S=15\text{A}, di/dt=100\text{A}/\mu\text{s}$	t_{rr}	-	7.2	-	ns
Reverse Recovery Charge		Q_{rr}	-	4.5	-	nC

RATINGS AND CHARACTERISTIC CURVES

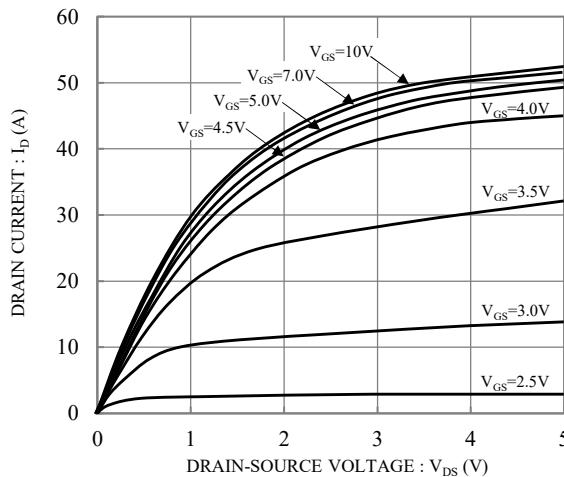


Fig.1 Typical Output Characteristics

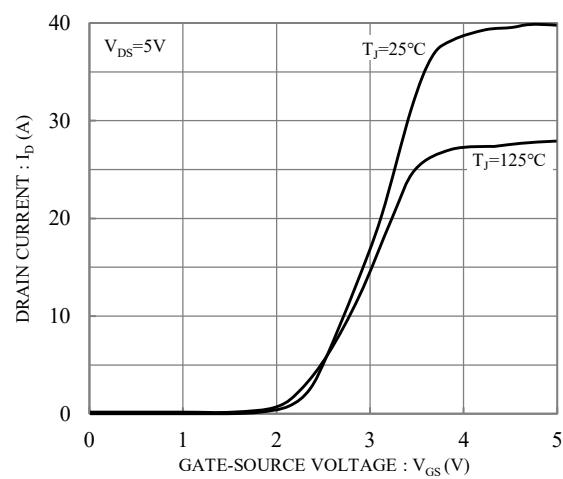


Fig.2 Typical Transfer Characteristics

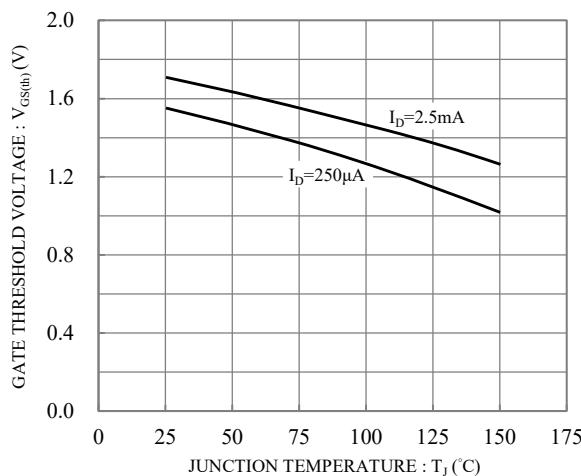


Fig.3 Gate Threshold Voltage vs. Junction Temperature

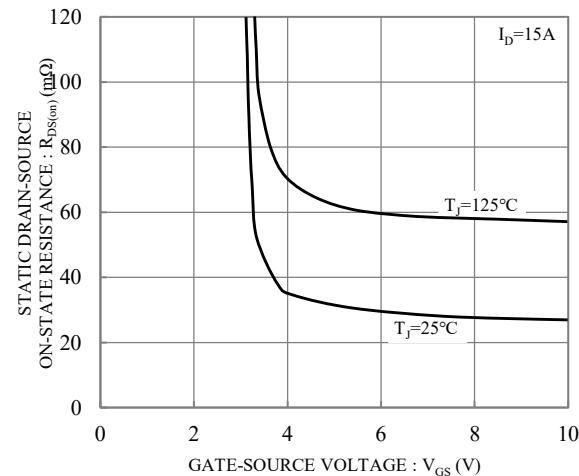


Fig.4 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

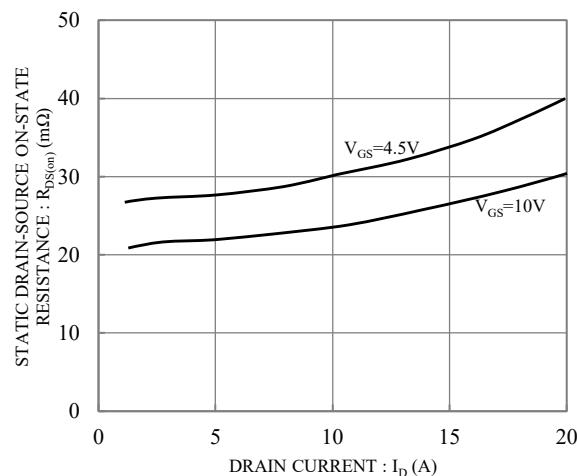


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

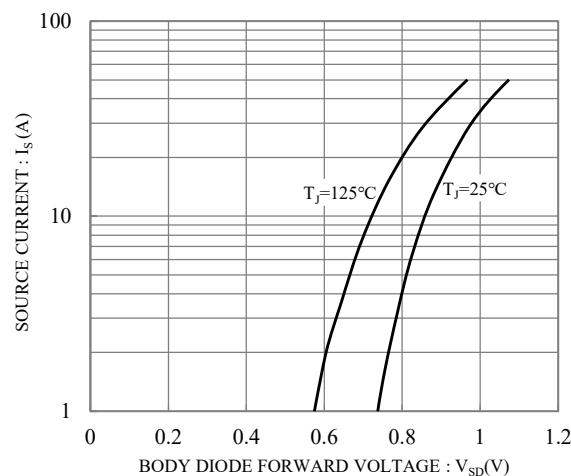


Fig.6 Body Diode Forward Voltage vs. Source Current

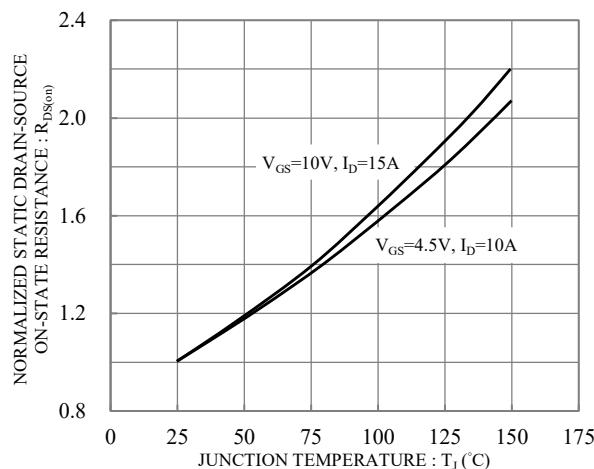


Fig.7 Drain-Source On-State Resistance vs. Junction Temperature

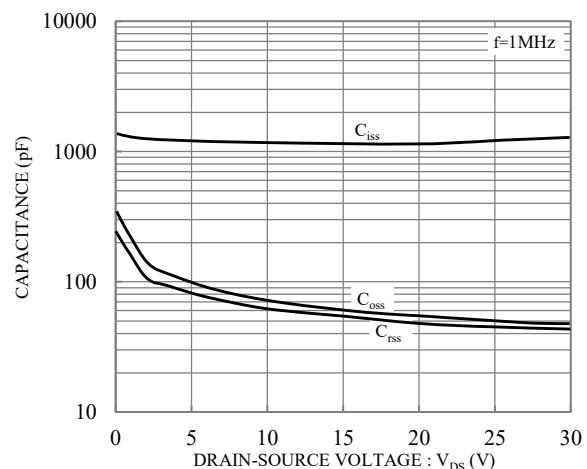


Fig.8 Capacitance vs. Drain-Source Voltage

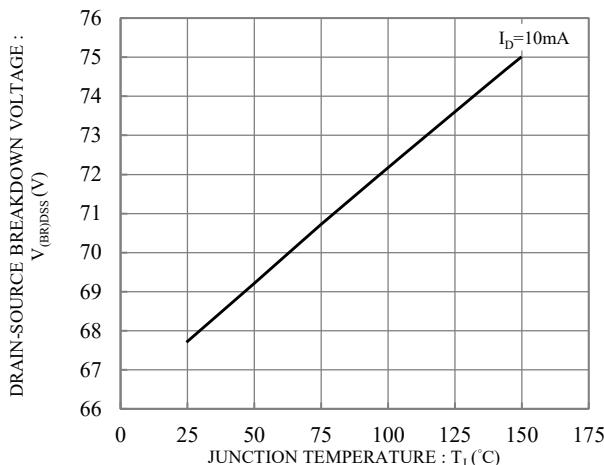


Fig.9 Breakdown Voltage vs. Junction Temperature

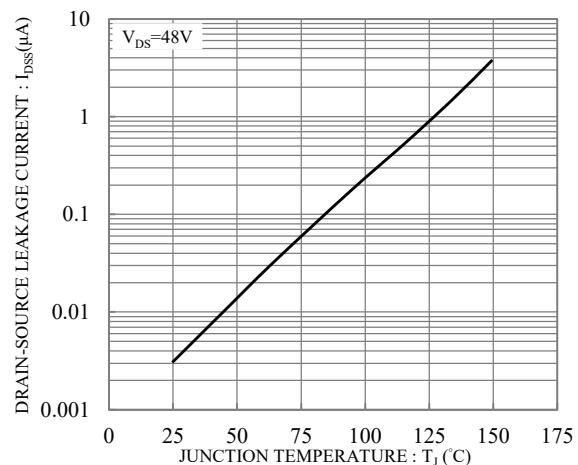


Fig.10 Drain-Source Leakage Current vs. Junction Temperature

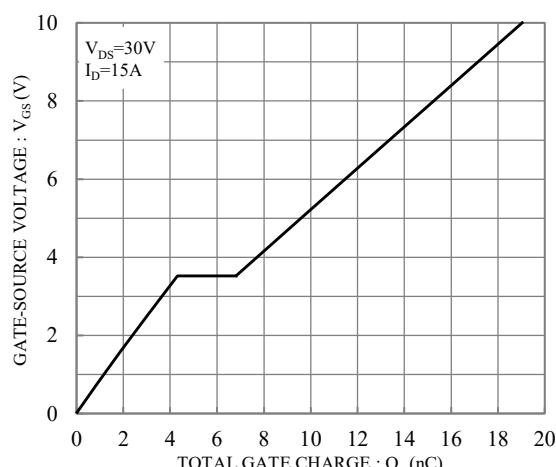


Fig.11 Gate Charge Characteristics

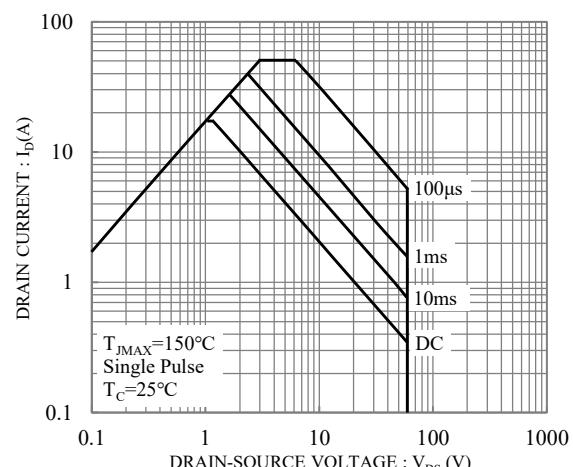


Fig.12 Safe Operation Area

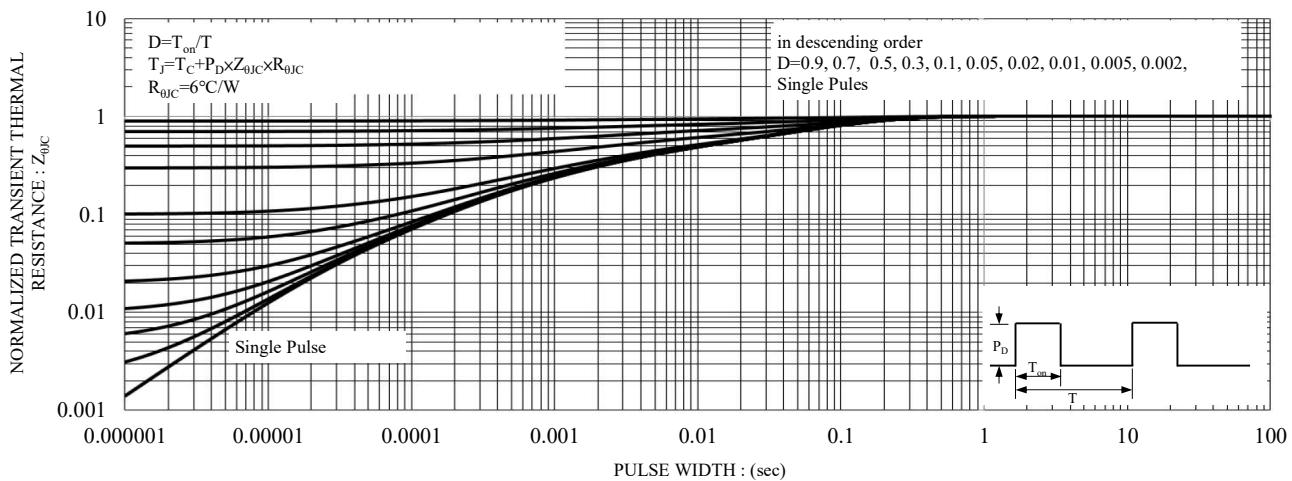


Fig.13 Maximum Transient Thermal Impedance

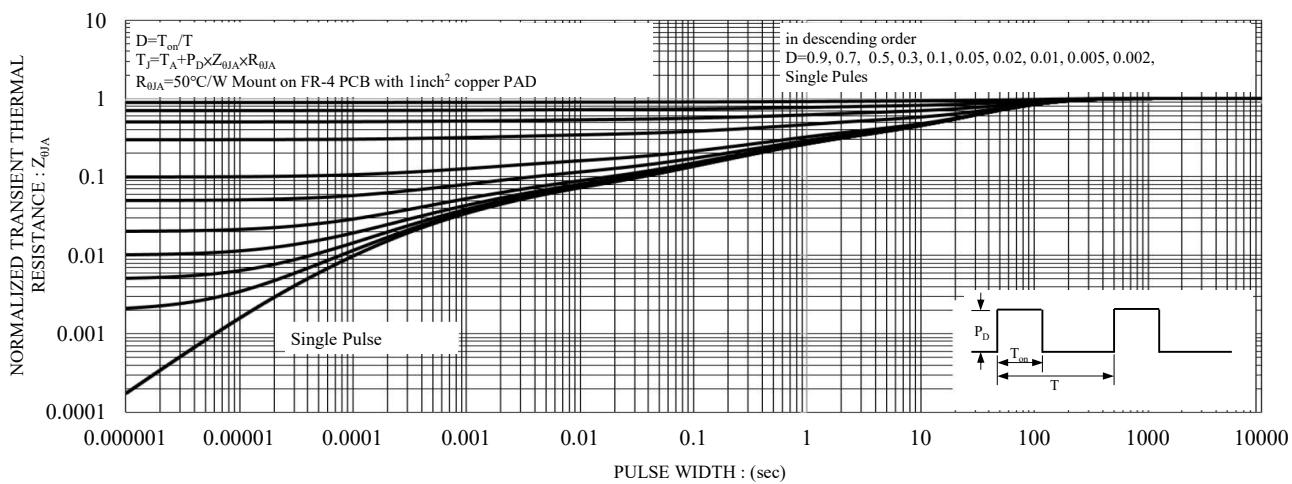
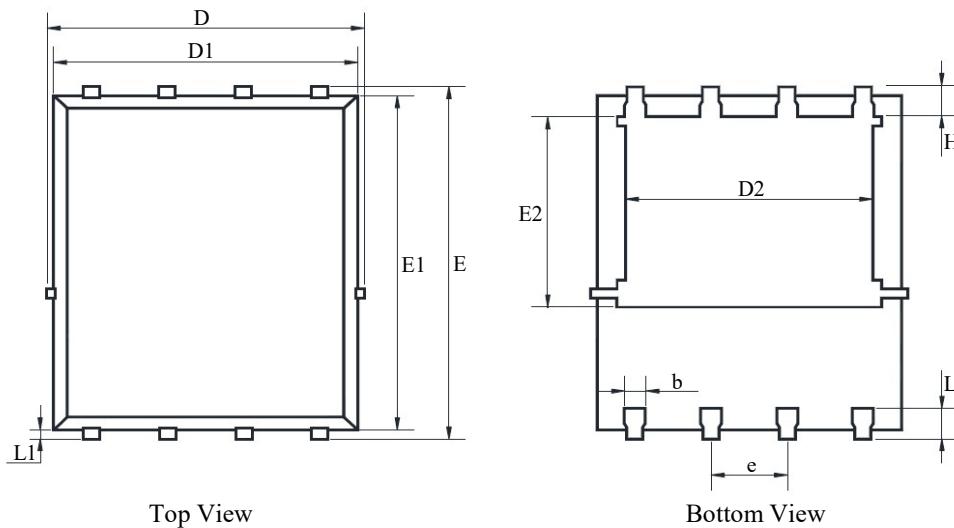


Fig.14 Maximum Transient Thermal Impedance

PACKAGE DIMENSION

DFN5x6-8L



Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	0.90	1.12	0.035	0.044
b	0.33	0.51	0.013	0.020
C	0.11	0.34	0.004	0.013
D	4.70	5.26	0.185	0.207
D1	4.70	5.10	0.185	0.201
D2	3.56	4.50	0.140	0.177
E	5.75	6.25	0.226	0.246
E1	5.60	6.00	0.220	0.236
E2	3.18	3.66	0.125	0.144
e	1.17	1.37	0.046	0.054
L	0.35	0.71	0.014	0.028
L1	0.06	0.20	0.002	0.008
H	0.35	0.71	0.014	0.028